

General Description

The STL140N6F7 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness.



DFN5X6-8L

General Features

V_{DS} =60V I_D =125A

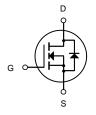
 $R_{DS(ON)}$ < 2.9m Ω @ V_{GS} =10V

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
STL140N6F7	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_C =25°C unless otherwise noted)

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	60		
Vgs	Gate-Source Voltage	±20	V	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V	125	А	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V	101	А	
Ірм	Pulsed Drain Current ²	641	А	
EAS	Single Pulse Avalanche Energy ³	189	mJ	
P _D @T _C =25°C	Total Power Dissipation ⁴	113	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
R _θ JC	Thermal Resistance from Junction-to-Ambient ³	1.11	°C/W	
R ₀ JA	Thermal Resistance Junction-Ambient ¹	39.4	°C/W	



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1.2	1.6	2.2	V
R _{DS(on)}	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =20A	-	2.4	2.9	mΩ
C _{iss}	Input Capacitance	\/ 00\/\/ 0\/	-	4610	6915	pF
Coss	Output Capacitance	V _{DS} =30V,V _{GS} =0V, f=1.0MHz	-	2188	3282	pF
C _{rss}	Reverse Transfer Capacitance	I-I.UIVITZ	-	66	132	pF
Qg	Total Gate Charge	\/ -20\/ -40A	-	74.37	111.56	nC
Q _{gs}	Gate-Source Charge	V_{DS} =30V, I_{D} =40A, V_{GS} =10V	-	17.26	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	9.44	18.88	nC
t _{d(on)}	Turn-on Delay Time		-	14.13	-	ns
t _r	Turn-on Rise Time	V _{DD} =30V, I _D =40A,	-	63.73	-	ns
t _{d(off)}	Turn-off Delay Time	$R_G=2.7\Omega, V_{GS}=10V$	-	46.8	-	ns
t _f	Turn-off Fall Time		-	105.07	-	ns
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	125	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	641	Α
V _{SD}	Drain to Source Diode Forward	V _{GS} =0V, I _S =40A	-	-	1.2	V
	Voltage	33 - 1 , 13 - 13 - 1				
t _{rr}	Body Diode Reverse Recovery Time	 Tյ=25℃,	-	52.78	105.56	ns
Qrr	Body Diode Reverse Recovery Charge	I _F =40A,dI/dt=100A/μs	-	56.31	112.62	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: $T_J = 25\,^{\circ}\mathrm{C}$, $V_{DD} = 30V$, $V_G = 10V$, $R_G = 25\Omega$, L = 0.5mH , $I_{AS} = 12A$
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Characteristics

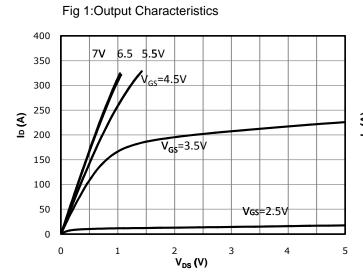


Fig 2:Transfer Characteristics

V_{DS}=5V

V_{DS}

Vgs(V)

Fig 3: Rds(on) vs Drain Current and Gate Voltage

4.0

3.5

3.0

V_{GS}=10V

2.5

2.0

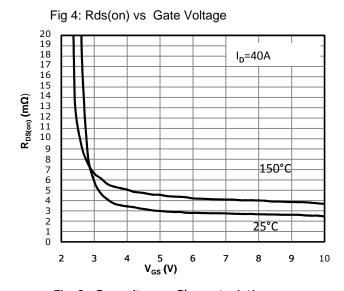
1.5

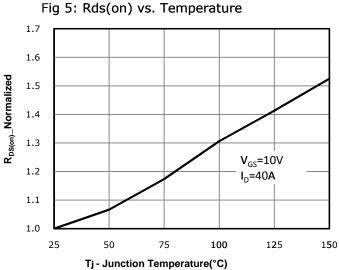
1.0

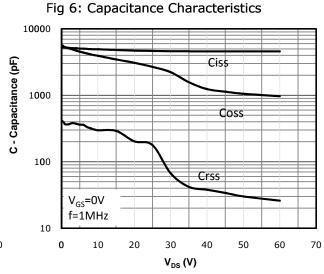
0

50

100

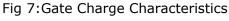






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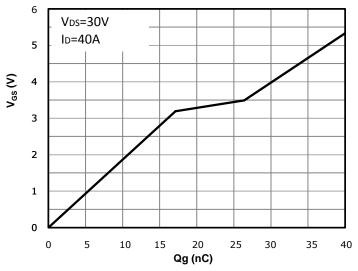


Fig 8: Body-diode Forward Characteristics

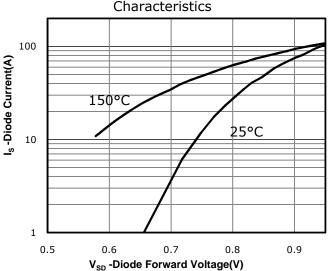


Fig 9: Power Dissipation

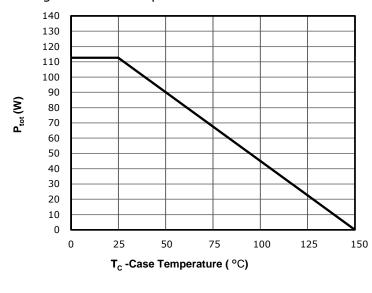


Fig 10: Drain Current Derating

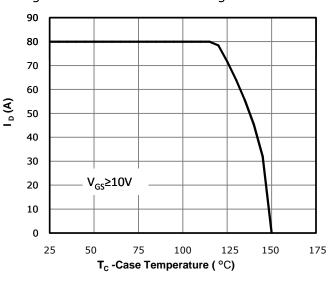
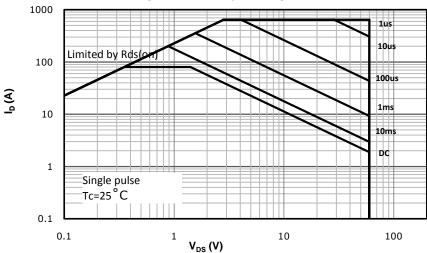
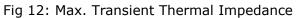
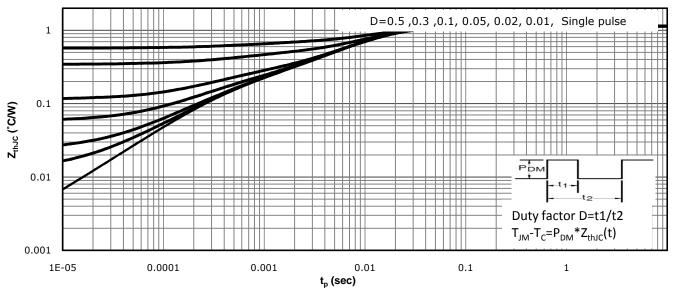


Fig 11: Safe Operating Area

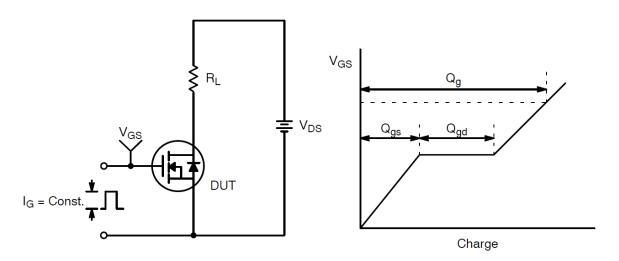




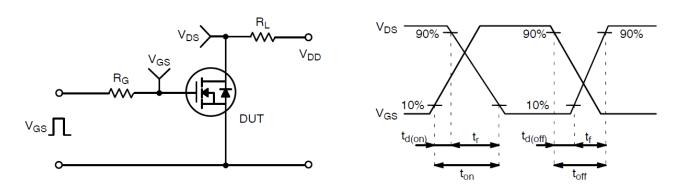




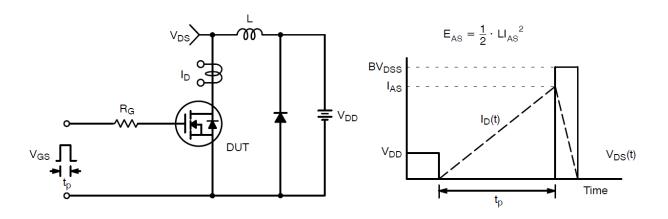
Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform



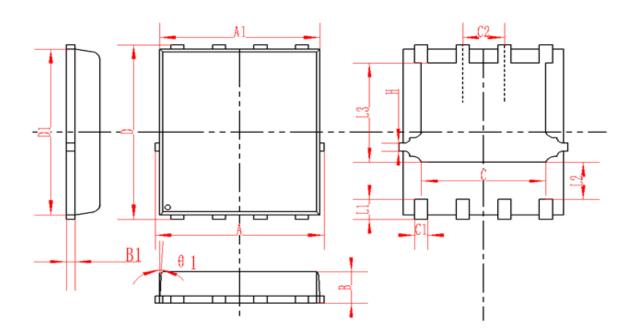
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



DFN5X6-8L Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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